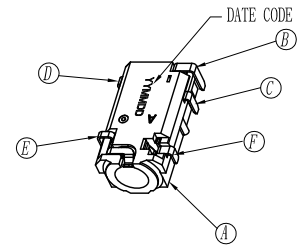


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCE RELEASE	ZHOULQ	2011.09.06
B	ECN NO:C110289	ZHOULQ	2011.10.18
C	ECN:C120005 ADD MATING DRAWING	Daowen	2012.02.21



DETAIL: A
SCALE 9:1

- SPECIFICATIONS:**
- ELECTRICAL CHARACTERISTICS:**
 - 1-1. RATING: 12V 1A
 - 1-2. CONTACT RESISTANCE: 30m MAX(BEFORE) Ω
 - 1-3. DIELECTRIC VOLTAGE WITHSTAND: 500V AC FOR ONE MINUTE
 - 1-4. INSULATION RESISTANCE: 100M MIN. MEASURED BY 500 VDC
 - MECHANICAL CHARACTERISTICS:**
 - 2-1. INSERTED FORCE : 0.3 \pm 0.0 Kgf
 - 2-2. WITHDRAWAL FORCE : 0.3 \pm 0.0 Kgf
 - LIFE TEST:** 5,000 CYCLES MIN.
 - TO CONFORM TO THE SINGATRON HSF SPECIFICATION.**
 - HALOGEN FREE PRODUCT IDENTIFICATION MARK:**
 - HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:**
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.**
 - PACKAGING :TAPE & REEL.**

RECOMMENDED P.C.B. LAYOUT
TOP VIEW (TOLERANCE: ± 0.05)

F	RING-B	1	COPPER ALLOY 0.2t	GOLD FLASH
E	EARTH	1	COPPER ALLOY 0.2t	GOLD FLASH
D	RING-A	1	COPPER ALLOY 0.2t	GOLD FLASH
C	TIP	1	COPPER ALLOY 0.2t	GOLD FLASH
B	SHUNT	1	COPPER ALLOY 0.2t	GOLD FLASH
A	BODY	1	HI-TEMP THERMOPLASTIC	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司		
DECIMALS:		TITLE		
X	± 0.5	·3.5 PHONE JACK		
X.X	± 0.3	DWN	PART NO. 2SJ2321-009111F	
X.XX	± 0.2	CHKD	SCALE 3 : 1	UNIT: mm
		APVD	SIZE: A3	SHEET: 1OF1
			REV: C	
CUSTOMER COPY				